



MMIC VCO w/ HALF FREQUENCY OUTPUT & DIVIDE-BY-4, 13.6 - 14.9 GHz

Typical Applications

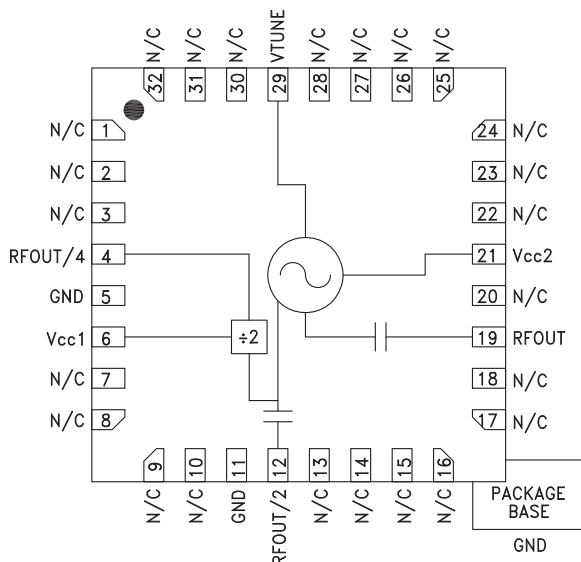
Low noise MMIC VCO w/Half Frequency, Divide-by-4 Outputs for:

- VSAT Radio
- Point to Point/Multipoint Radio
- Test Equipment & Industrial Controls
- Military End-Use

Features

- Dual Output: Fo = 13.6 - 14.9 GHz
Fo/2 = 6.8 - 7.45 GHz
- Pout: +7 dBm
- Phase Noise: -110 dBc/Hz @100 kHz Typ.
- No External Resonator Needed
- 32 Lead Ceramic 5x5mm SMT Package: 25mm²

Functional Diagram



General Description

The HMC531LP5 & HMC531LP5E are GaAs InGaP Heterojunction Bipolar Transistor (HBT) MMIC VCOs. The HMC531LP5 & HMC531LP5E integrate resonators, negative resistance devices, varactor diodes and feature half frequency and divide-by-4 outputs. The VCO's phase noise performance is excellent over temperature, shock, and process due to the oscillator's monolithic structure. Power output is +7 dBm typical from a +5V supply voltage. The prescaler function can be disabled to conserve current if not required. The voltage controlled oscillator is packaged in a leadless QFN 5x5 mm surface mount package, and requires no external matching components.

Electrical Specifications, T_A = +25° C, Vcc1, Vcc2 = +5V

| Parameter | Min. | Typ. | Max. | Units | |
|--|-------------|-------------|------|--------|----|
| Frequency Range | Fo | 13.6 - 14.9 | | GHz | |
| | Fo/2 | 6.8 - 7.45 | | GHz | |
| Power Output | RFOUT | +3 | +10 | dBm | |
| | RFOUT/2 | +8 | +14 | dBm | |
| | RFOUT/4 | -9 | -3 | dBm | |
| SSB Phase Noise @ 100 kHz Offset, Vtune= +5V @ RFOUT | | -110 | | dBc/Hz | |
| Tune Voltage | Vtune | 2 | 13 | V | |
| Supply Current | Icc1 & Icc2 | 220 | 260 | 300 | mA |
| Tune Port Leakage Current (Vtune= 13V) | | | 10 | µA | |
| Output Return Loss | | 8 | | dB | |
| Harmonics/Subharmonics | 1/2 | 25 | | dBc | |
| | 3/2 | 35 | | dBc | |
| | 2nd | 18 | | dBc | |
| | 3rd | 40 | | dBc | |
| Pulling (into a 2.0:1 VSWR) | | 5 | | MHz pp | |
| Pushing @ Vtune= 5V | | 6 | | MHz/V | |
| Frequency Drift Rate | | 1.2 | | MHz/°C | |

For price, delivery, and to place orders, please contact Hittite Microwave Corporation:

SUNSTAR 微波光电 <http://www.hittite.com> / TEL:0755-83396822 FAX:0755-83376182 E-MAIL: szss20@163.com

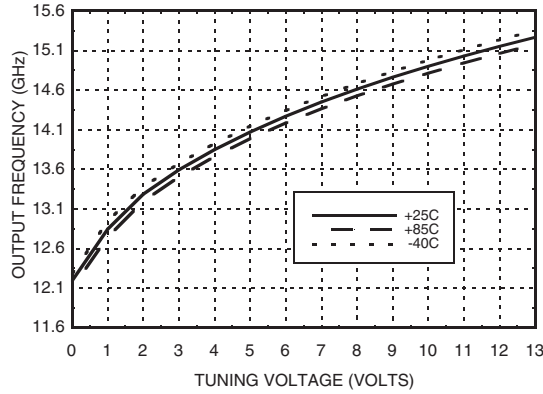
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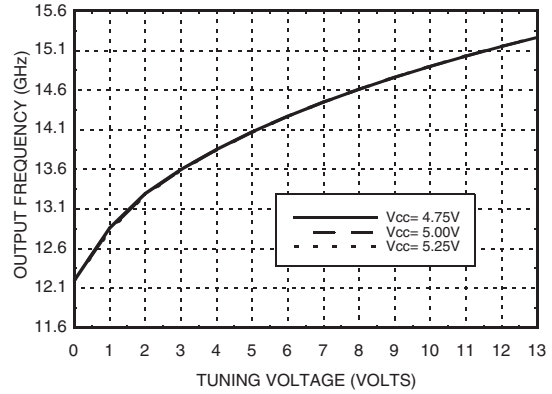
HMC531LP5 / 531LP5E

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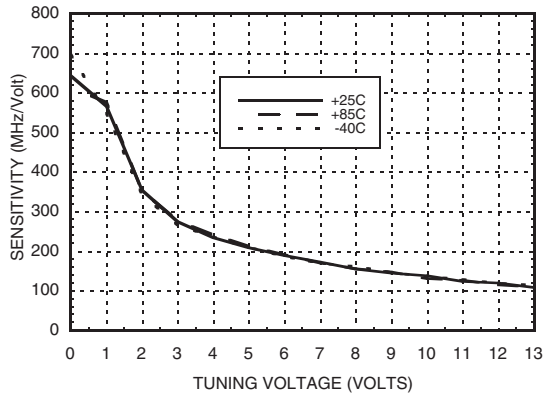
Frequency vs. Tuning Voltage, Vcc = +5V



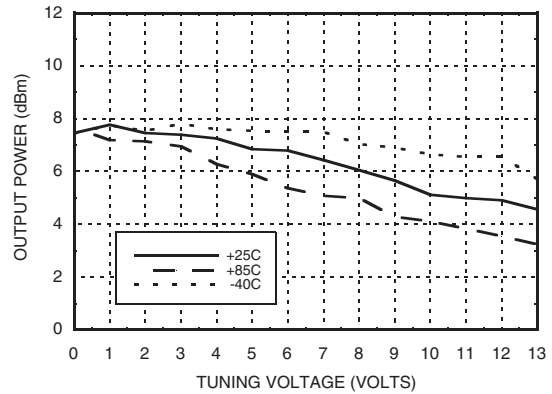
Frequency vs. Tuning Voltage, T = 25°C



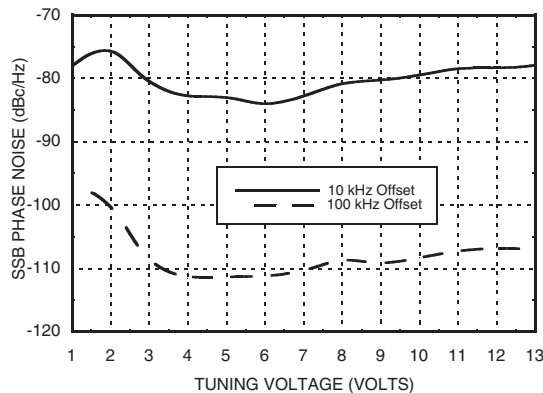
Sensitivity vs. Tuning Voltage, Vcc = +5V



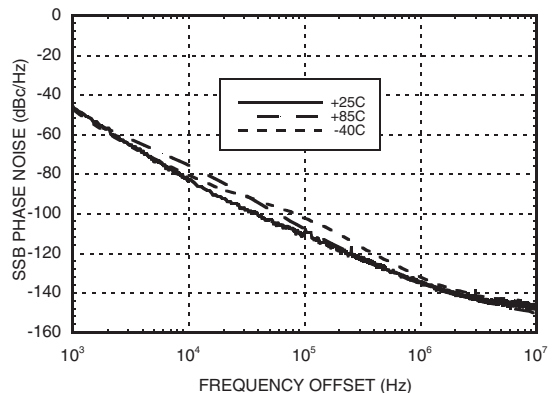
Output Power vs. Tuning Voltage, Vcc = +5V



SSB Phase Noise vs. Tuning Voltage



SSB Phase Noise @ Vtune = +5V

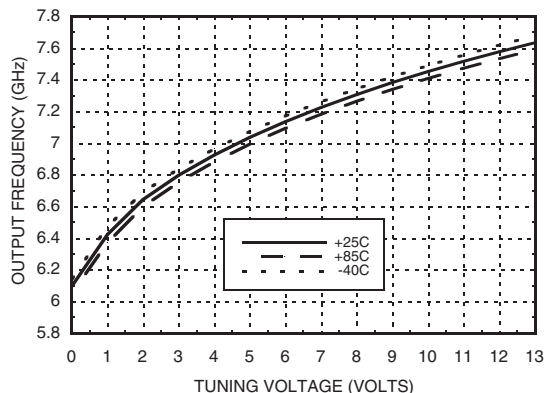




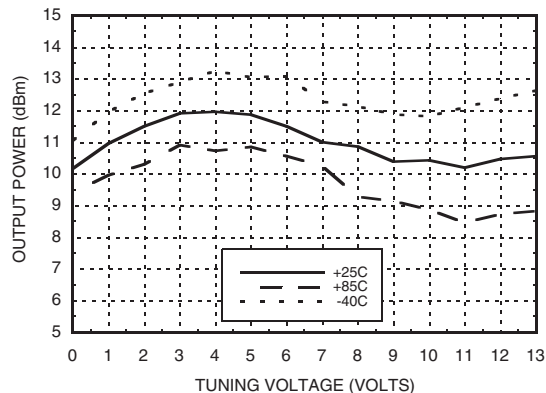
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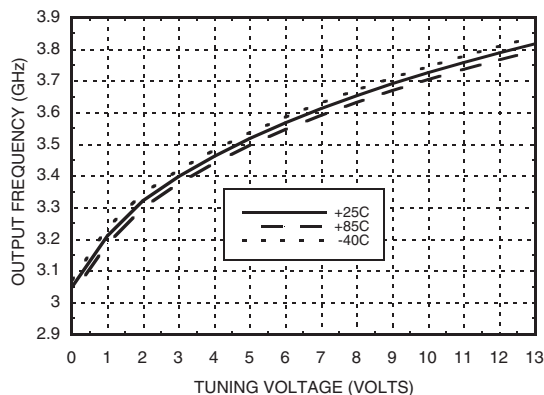
RFOUT/2 Frequency vs. Tuning Voltage, Vcc= +5V



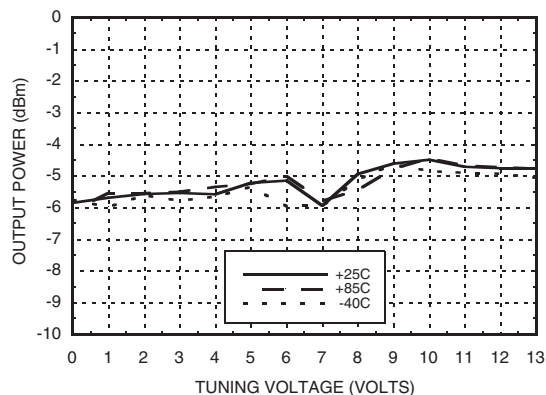
RFOUT/2 Output Power vs. Tuning Voltage, Vcc= +5V



Divide-by-4 Frequency vs. Tuning Voltage, Vcc= +5V



Divide-by-4 Output Power vs. Tuning Voltage, Vcc= +5V



Absolute Maximum Ratings

| | |
|--|----------------|
| Vcc1, Vcc2 | +5.5 Vdc |
| Vtune | 0 to +15V |
| Junction Temperature | 135 °C |
| Continuous P _{diss} (T=85 °C) (derate 37 mW/C above 85 °C) | 1.85 W |
| Thermal Resistance (junction to ground paddle) | 27 °C/W |
| Storage Temperature | -65 to +150 °C |
| Operating Temperature | -40 to +85 °C |
| ESD Sensitivity (HBM) | Class 1A |

Typical Supply Current vs. Vcc

| Vcc (V) | I _{cc} (mA) |
|---------|----------------------|
| 4.75 | 235 |
| 5.00 | 260 |
| 5.25 | 275 |

Note: VCO will operate over full voltage range shown above.



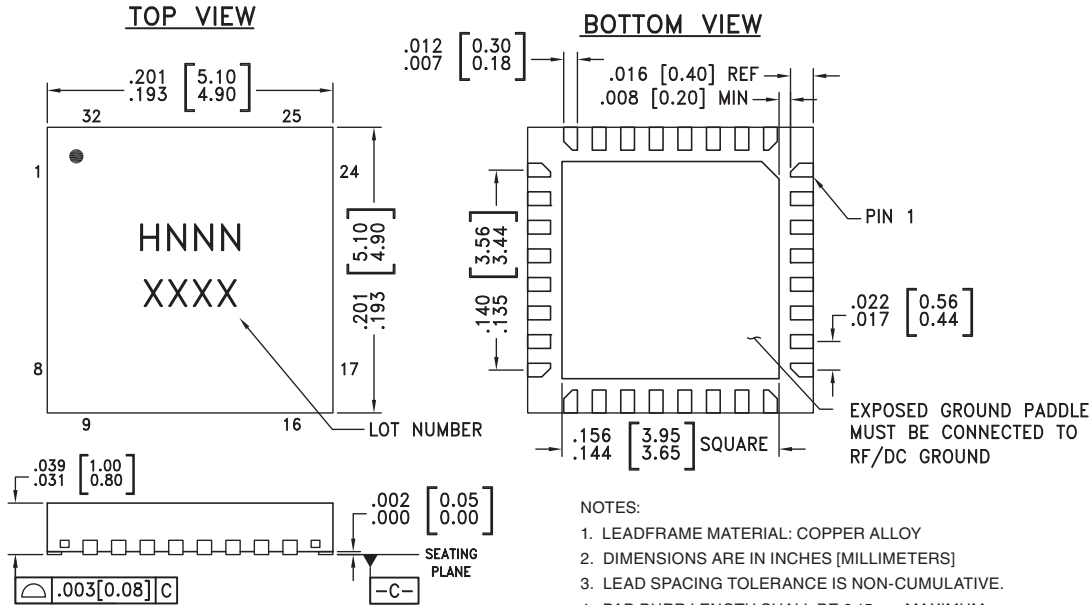
**ELECTROSTATIC SENSITIVE DEVICE
OBSERVE HANDLING PRECAUTIONS**

HMC531LP5 / 531LP5E

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Outline Drawing



Package Information

| Part Number | Package Body Material | Lead Finish | MSL Rating | Package Marking ^[3] |
|-------------|--|---------------|---------------------|--------------------------------|
| HMC531LP5 | Low Stress Injection Molded Plastic | Sn/Pb Solder | MSL3 ^[1] | H531 XXXX |
| HMC531LP5E | RoHS-compliant Low Stress Injection Molded Plastic | 100% matte Sn | MSL3 ^[2] | H531 XXXX |

[1] Max peak reflow temperature of 235 °C

[2] Max peak reflow temperature of 260 °C

[3] 4-Digit lot number XXXX

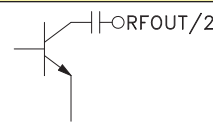
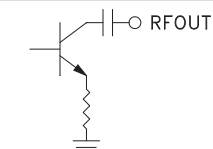
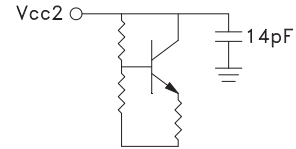
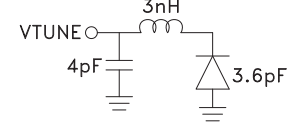

Pin Descriptions

| Pin Number | Function | Description | Interface Schematic |
|--|----------|---|---------------------|
| 1 - 3, 7 - 10, 13 - 18, 20, 22 - 28, 30 - 32 | N/C | No Connection. These pins may be connected to RF/DC ground. Performance will not be affected. | |
| 4 | RFOUT/4 | Divide-by-4 Output. | |
| 6 | Vcc1 | Supply Voltage for prescaler. If prescaler is not required, this pin may be left open to conserve 65 mA of current. | |

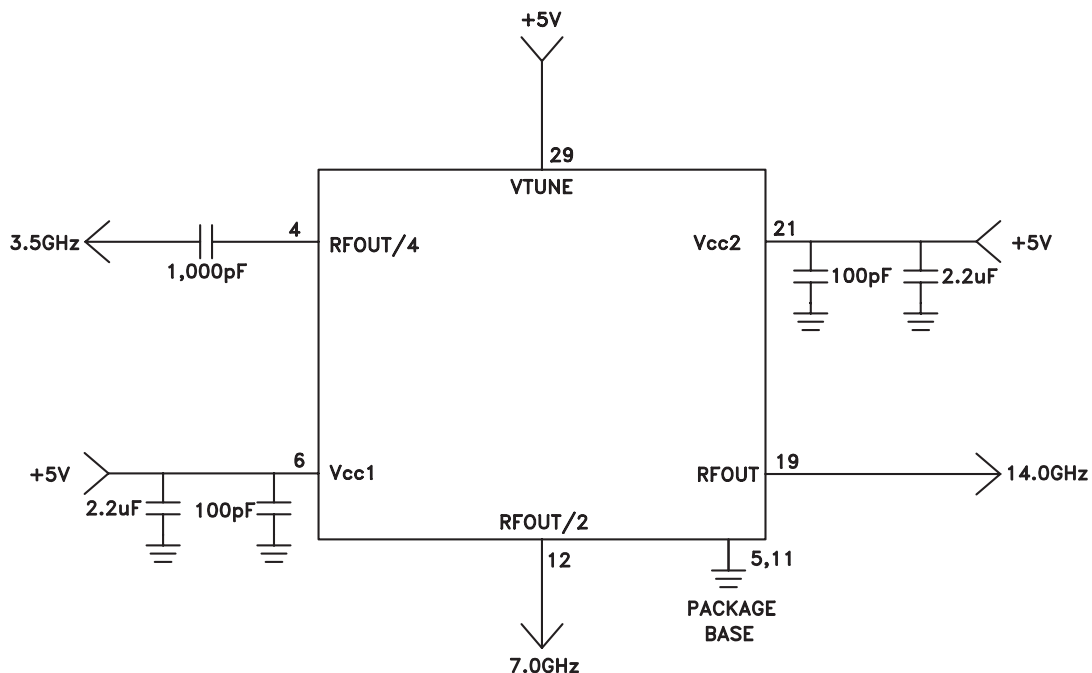


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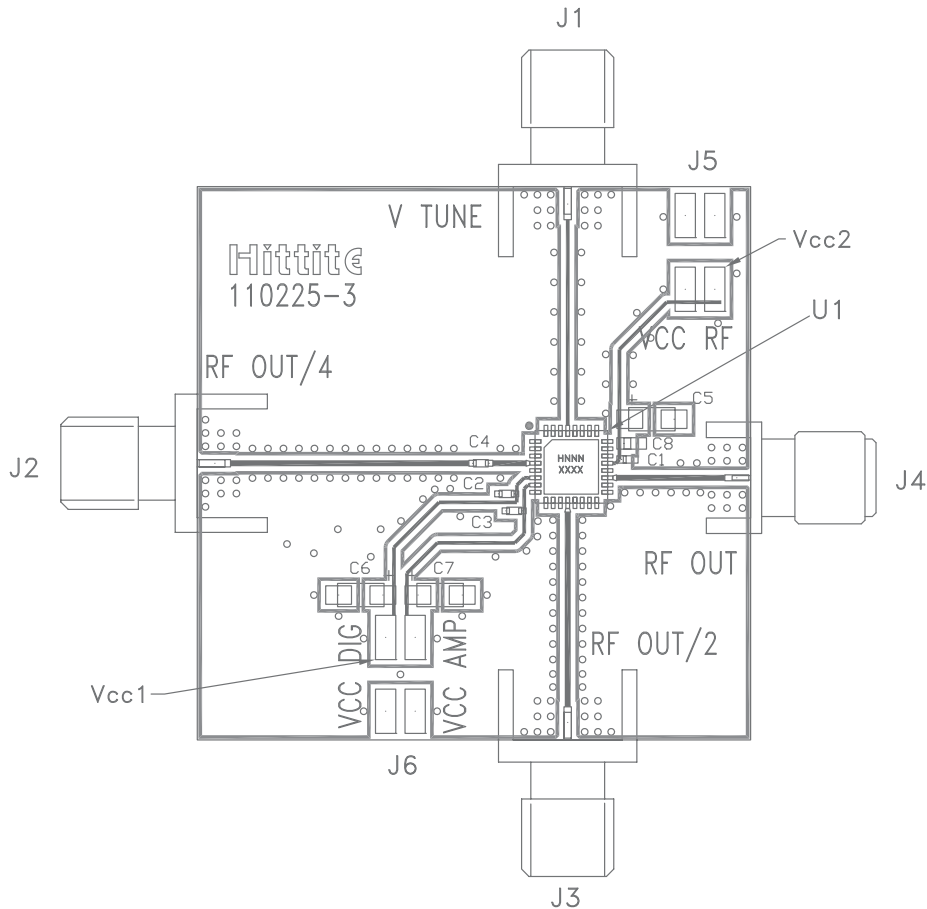
| Pin Number | Function | Description | Interface Schematic |
|--------------|----------|---|---|
| 12 | RFOUT/2 | Half frequency output (AC coupled). |  |
| 19 | RF OUT | RF output (AC coupled). |  |
| 21 | Vcc2 | Supply Voltage, +5V |  |
| 29 | VTUNE | Control Voltage and Modulation Input. Modulation bandwidth dependent on drive source impedance. See "Determining the FM Bandwidth of a Wideband Varactor Tuned VCO" application note. |  |
| 5, 11 Paddle | GND | Package bottom has an exposed metal paddle that must be connected to RF/DC ground. |  |

Typical Application Circuit





Evaluation PCB



List of Materials for Evaluation PCB 110227 [1]

| Item | Description |
|---------|-------------------------------|
| J1 - J4 | PCB Mount SMA RF Connector |
| J5 - J6 | 2 mm DC Header |
| C1 - C3 | 100 pF Capacitor, 0402 Pkg. |
| C4 | 1,000 pF Capacitor, 0402 Pkg. |
| C5 - C7 | 2.2 μF Tantalum Capacitor |
| U1 | HMC531LP5(E) VCO |
| PCB [2] | 110225 Eval Board |

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Arlon 25FR

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and backside ground paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.